

### APPLICATIONS

- Rectification
- Freewheel Diode
- DC Motor Control
- Power Supplies
- Welding
- Battery Chargers

### FEATURES

- Double Side Cooling
- High Surge Capability

### VOLTAGE RATINGS

| Type Number | Repetitive Peak Reverse Voltage<br>$V_{RRM}$<br>V | Conditions                 |
|-------------|---------------------------------------------------|----------------------------|
| DNB63 15    | 1500                                              | $V_{RSM} = V_{RRM} + 100V$ |
| DNB63 14    | 1400                                              |                            |
| DNB63 13    | 1300                                              |                            |
| DNB63 12    | 1200                                              |                            |
| DNB63 11    | 1100                                              |                            |

Lower voltage grades available.

### KEY PARAMETERS

|             |        |
|-------------|--------|
| $V_{RRM}$   | 1500V  |
| $I_{F(AV)}$ | 5794A  |
| $I_{FSM}$   | 57000A |

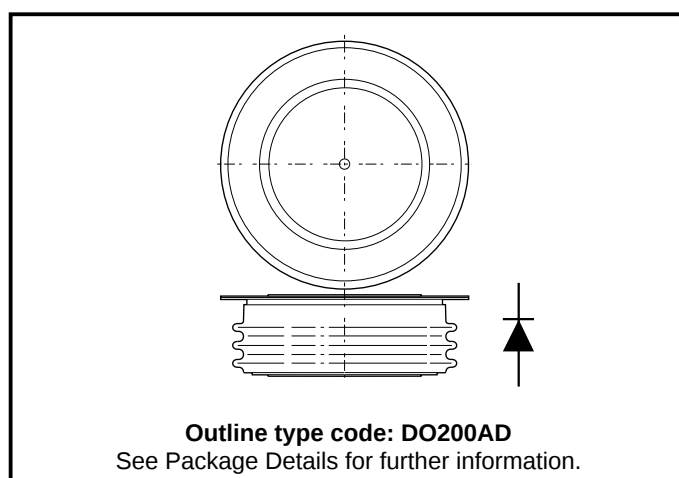


Fig. 1 Package outline

## CURRENT RATINGS

 $T_{case} = 75^{\circ}\text{C}$  unless otherwise stated

| Symbol                                 | Parameter                           | Conditions               | Max. | Units |
|----------------------------------------|-------------------------------------|--------------------------|------|-------|
| <b>Double Side Cooled</b>              |                                     |                          |      |       |
| $I_{F(AV)}$                            | Mean forward current                | Half wave resistive load | 5794 | A     |
| $I_{F(RMS)}$                           | RMS value                           | -                        | 9101 | A     |
| $I_F$                                  | Continuous (direct) forward current | -                        | 7934 | A     |
| <b>Single Side Cooled (Anode side)</b> |                                     |                          |      |       |
| $I_{F(AV)}$                            | Mean forward current                | Half wave resistive load | 4230 | A     |
| $I_{F(RMS)}$                           | RMS value                           | -                        | 6645 | A     |
| $I_F$                                  | Continuous (direct) forward current | -                        | 5468 | A     |

 $T_{case} = 100^{\circ}\text{C}$  unless otherwise stated

| Symbol                                 | Parameter                           | Conditions                                                 | Max. | Units |
|----------------------------------------|-------------------------------------|------------------------------------------------------------|------|-------|
| <b>Double Side Cooled</b>              |                                     |                                                            |      |       |
| $I_{F(AV)}$                            | Mean forward current                | Half wave resistive load, $T_{case} = 100^{\circ}\text{C}$ | 4850 | A     |
| $I_{F(RMS)}$                           | RMS value                           | $T_{case} = 100^{\circ}\text{C}$                           | 7615 | A     |
| $I_F$                                  | Continuous (direct) forward current | $T_{case} = 100^{\circ}\text{C}$                           | 6600 | A     |
| <b>Single Side Cooled (Anode side)</b> |                                     |                                                            |      |       |
| $I_{F(AV)}$                            | Mean forward current                | Half wave resistive load, $T_{case} = 100^{\circ}\text{C}$ | 3540 | A     |
| $I_{F(RMS)}$                           | RMS value                           | $T_{case} = 100^{\circ}\text{C}$                           | 5560 | A     |
| $I_F$                                  | Continuous (direct) forward current | $T_{case} = 100^{\circ}\text{C}$                           | 4500 | A     |

## SURGE RATINGS

| Symbol    | Parameter                              | Conditions                                | Max.               | Units            |
|-----------|----------------------------------------|-------------------------------------------|--------------------|------------------|
| $I_{FSM}$ | Surge (non-repetitive) forward current | 10ms half sine; $T_{case} = 190^{\circ}C$ | 52.0               | kA               |
| $I^2t$    | $I^2t$ for fusing                      | $V_R = 50\% V_{RRM} - 1/4$ sine           | $13.5 \times 10^6$ | A <sup>2</sup> s |
| $I_{FSM}$ | Surge (non-repetitive) forward current | 10ms half sine; $T_{case} = 190^{\circ}C$ | 57.0               | kA               |
| $I^2t$    | $I^2t$ for fusing                      | $V_R = 0$                                 | $16.2 \times 10^6$ | A <sup>2</sup> s |

## THERMAL AND MECHANICAL DATA

| Symbol        | Parameter                             | Conditions                                   |             | Min. | Max.  | Units         |
|---------------|---------------------------------------|----------------------------------------------|-------------|------|-------|---------------|
| $R_{th(j-c)}$ | Thermal resistance - junction to case | Double side cooled                           | dc          | -    | 0.013 | $^{\circ}C/W$ |
|               |                                       | Single side cooled                           | Anode dc    | -    | 0.021 | $^{\circ}C/W$ |
|               |                                       |                                              | Cathode dc  | -    | 0.034 | $^{\circ}C/W$ |
| $R_{th(c-h)}$ | Thermal resistance - case to heatsink | Clamping force 45.0kN with mounting compound | Double side | -    | 0.003 | $^{\circ}C/W$ |
|               |                                       |                                              | Single side | -    | 0.006 | $^{\circ}C/W$ |
| $T_{vj}$      | Virtual junction temperature          | Forward (conducting)                         |             | -    | 200   | $^{\circ}C$   |
|               |                                       | Reverse (blocking)                           |             | -    | 190   | $^{\circ}C$   |
| $T_{stg}$     | Storage temperature range             |                                              |             | -55  | 190   | $^{\circ}C$   |
| -             | Clamping force                        |                                              |             | 40.0 | 48.0  | kN            |

CHARACTERISTICS

| Symbol           | Parameter             | Conditions                                                                                                | Min. | Max.  | Units |
|------------------|-----------------------|-----------------------------------------------------------------------------------------------------------|------|-------|-------|
| V <sub>FM</sub>  | Forward voltage       | At 3000A peak, T <sub>case</sub> = 25°C                                                                   | -    | 1.05  | V     |
| I <sub>RRM</sub> | Peak reverse current  | At V <sub>RRM</sub> , T <sub>case</sub> = 190°C                                                           | -    | 60    | mA    |
| Q <sub>S</sub>   | Total stored charge   | I <sub>F</sub> = 1000A, dI <sub>RR</sub> /dt = 50A/μs<br>T <sub>case</sub> = 175°C, V <sub>R</sub> = 100V | -    | 4000  | μC    |
| I <sub>RM</sub>  | Peak recovery current |                                                                                                           | -    | 600   | A     |
| t <sub>rr</sub>  | Reverse recovery time |                                                                                                           | -    | 20    | μs    |
| V <sub>TO</sub>  | Threshold voltage     | At T <sub>vj</sub> = 190°C                                                                                | -    | 0.75  | V     |
| r <sub>T</sub>   | Slope resistance      | At T <sub>vj</sub> = 190°C                                                                                | -    | 0.046 | mΩ    |

CURVES

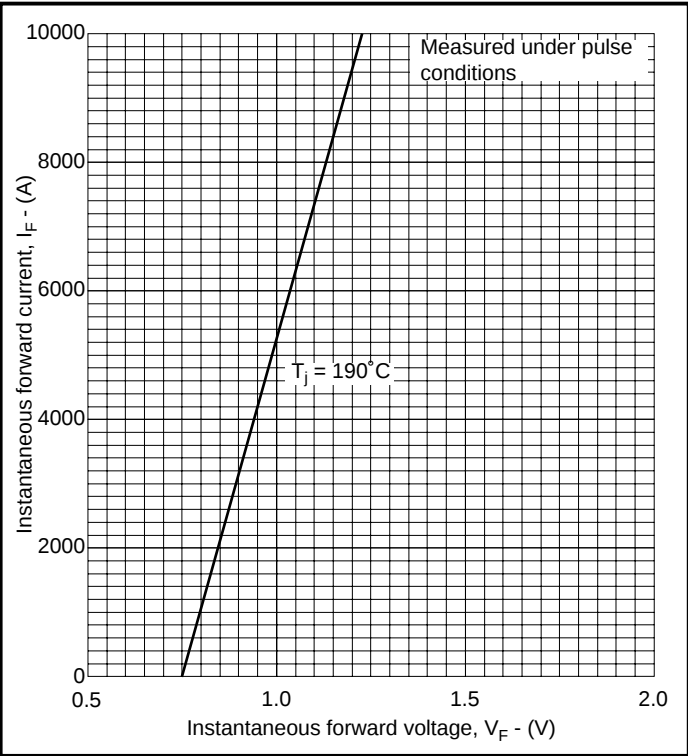


Fig.2 Maximum (limit) forward characteristics

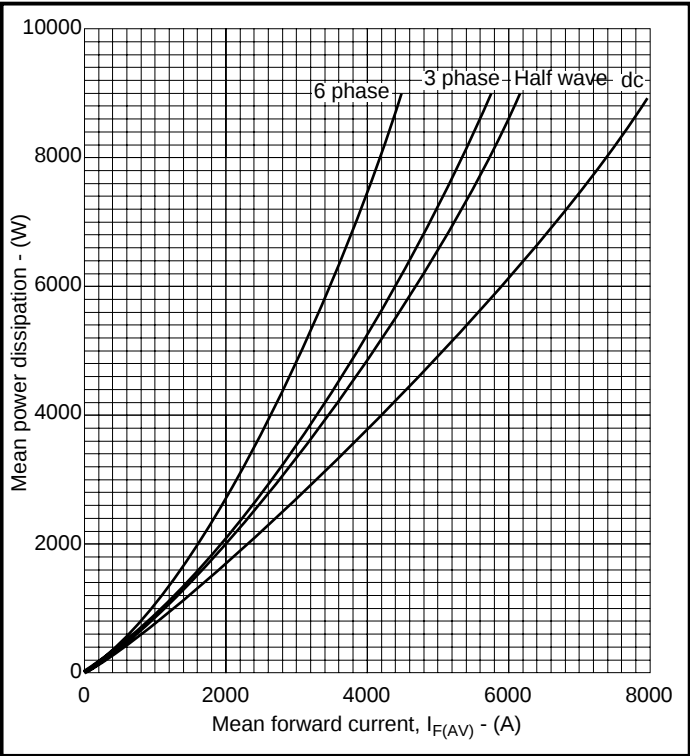


Fig.3 Dissipation curves

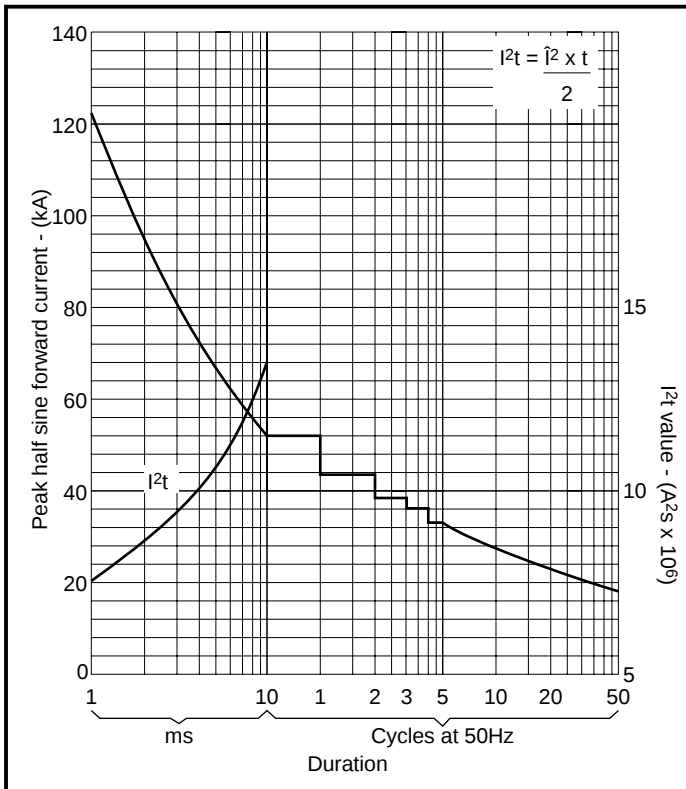
V<sub>FM</sub> Equation:-

$$V_{FM} = A + B \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

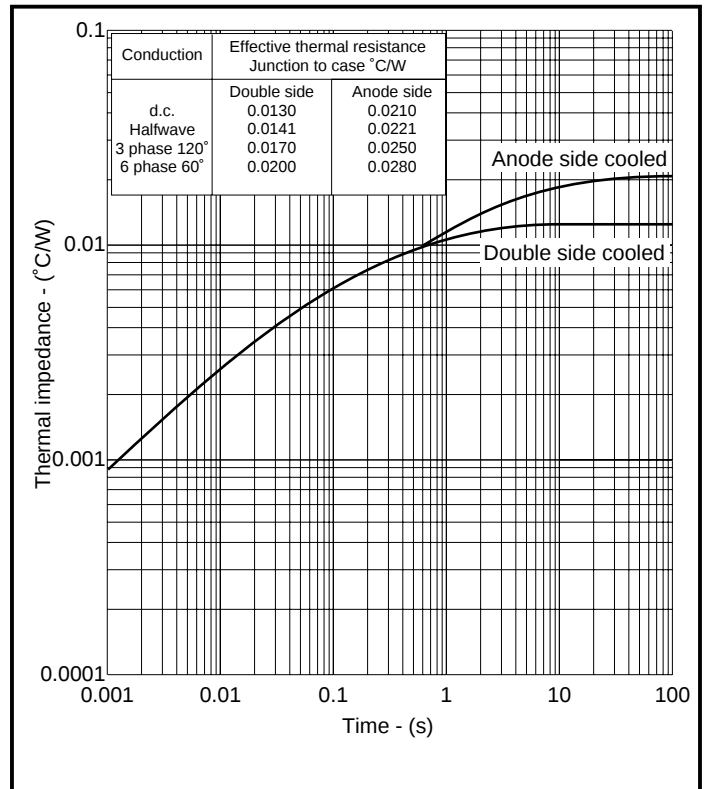
Where

A = 0.517184  
B = 0.035583  
C = 4.94 × 10<sup>-5</sup>  
D = -0.0011

these values are valid for T<sub>j</sub> = 125°C for I<sub>F</sub> 500A to 10000A



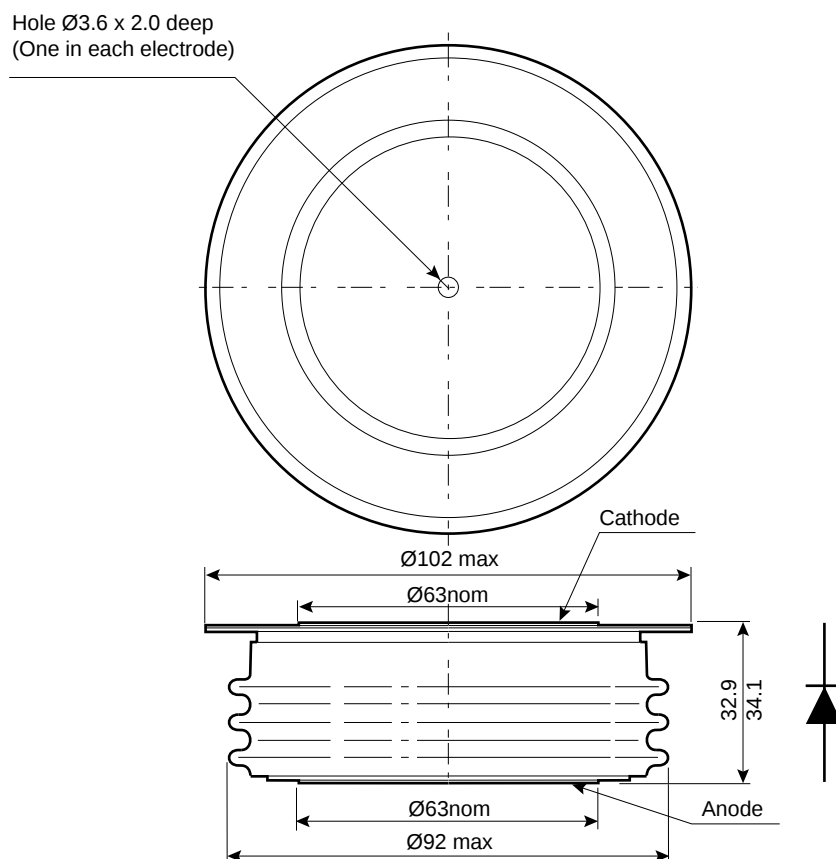
**Fig.4 Surge (non-repetitive) forward current vs time (with 50%  $V_{RRM}$  at  $T_{case}$  190°C)**



**Fig.5 Maximum (limit) transient thermal impedance - junction to case**

## PACKAGE DETAILS

For further package information, please contact your nearest Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



Nominal weight: 1100g  
Clamping force: 45kN  $\pm 10\%$

**Package outline type code: DO200AD**

### Note:

1. Package maybe supplied with pins and/or tags.

## POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink / clamping systems in line with advances in device types and the voltage and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group continues to offer high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the up to date CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete solution (PACs).

## DEVICE CLAMPS

Disc devices require the correct clamping force to ensure their safe operation. The PACs range offers a varied selection of pre-loaded clamps to suit all of our manufactured devices. This include cube clamps for single side cooling of 'T' 22mm

Clamps are available for single or double side cooling, with high insulation versions for high voltage assemblies.

Please refer to our application note on device clamping, AN4839

## HEATSINKS

Power Assembly has its own proprietary range of extruded aluminium heatsinks. They have been designed to optimise the performance of our semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest Sales Representative or Customer Services.



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**Preliminary Information:** The product is in design and development. The datasheet represents the product as it is understood but details may change.

**Advance Information:** The product design is complete and final characterisation for volume production is well in hand.

**No Annotation:** The product parameters are fixed and the product is available to datasheet specification.

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